

# TNG07N40PA

## N-Channel Enhancement Mode Power MOSFET

#### **Product Summary**

- $V_{DS} = 40V, I_D = 7A$
- $R_{DS(on)}$ < 18m $\Omega$  @ $V_{GS}$ = 10V
- $R_{DS(on)}$ < 25m $\Omega$  @ $V_{GS}$ = 4.5V

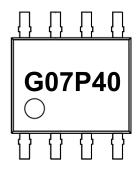
#### **Features**

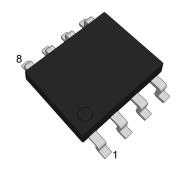
- Advanced Split Gate Trench Technology
- 100% Avalanche Tested
- RoHS and Reach Compliant
- Halogen and Antimony Free
- Moisture Sensitivity Level 3

## **Application**

- Load Switch
- PWM Application
- Power Management

## **Marking Code**



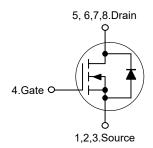


SOP-8

(Top View)

Pin	Description	
1,2,3	Source	
4	Gate	
5,6,7,8	Drain	

#### **Schematic Diagram**



#### **Absolute Maximum Ratings**

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	40	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	7	А
Drain Current-Pulsed Note1	I <sub>DM</sub>	27.2	Α
Maximum Power Dissipation	P <sub>D</sub>	2.0	W
Junction Temperature	TJ	150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

#### **Thermal Characteristics**

Thermal Resistance,Junction-to-Ambient Note2	R <sub>θJA</sub>	62.5	°C/W
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#### **Electrical Characteristics**

(T<sub>J</sub>=25°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
	OFF CHA	RACTERISTICS				
Drain-to-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	40			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V			1.0	uA
Gate-to-source Leakage Current	Igss	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±100	nA
	ON CHA	RACTERISTICS				
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.0	1.5	2.2	V
Drain-to-source On-resistance	Б	V <sub>GS</sub> =10V, I <sub>D</sub> =6A		15	18	mΩ
	R <sub>DS(on)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =5A		20	25	
Forward Trans conductance	<b>g</b> FS	V <sub>DS</sub> =5.0V, I <sub>D</sub> =6A			40	S
CHARGES, C	CAPACITAN	ICES AND GATE RESIS	TANCE			
Input Capacitance	Cıss	V <sub>GS</sub> =0V, f=1MHz, V <sub>DS</sub> =20V		410		pF
Output Capacitance	Coss			100		
Reverse Transfer Capacitance	Crss			35		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =20V, I <sub>D</sub> =6A		8.5		
Gate-to-Source Charge	Q <sub>G</sub> s			1.2		nC
Gate-to-Drain Charge	Q <sub>GD</sub>			2.4		
SI	WITCHING	CHARACTERISTICS				
Turn-On Delay Time	t <sub>d(ON)</sub>	$V_{GS}$ =10V, $V_{DS}$ =20V, $R_L$ =3.3 $\Omega$ , $R_{GEN}$ =3 $\Omega$		4.4		
Rise Time	tr			3.3		
Turn-Off Delay Time	t <sub>d(OFF)</sub>			15.8		ns
Fall Time	t <sub>f</sub>			3.2		
BODY DIODE CHARACTERISTICS						
Forward Voltage	VsD	V <sub>GS</sub> =0V, I <sub>S</sub> =1.0A	0.45		1.5	V

## **Typical Characteristic Curves**

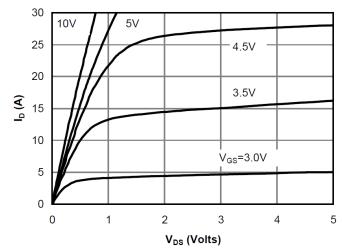


Fig 1: On-Region Characteristics

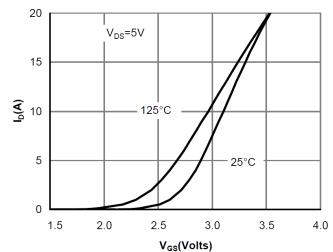


Figure 2: Transfer Characteristics

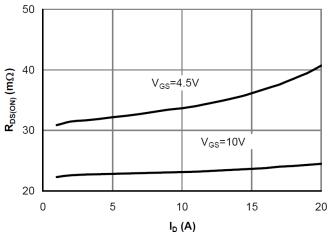


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

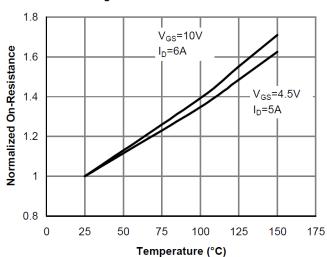


Figure 4: On-Resistance vs. Junction Temperature

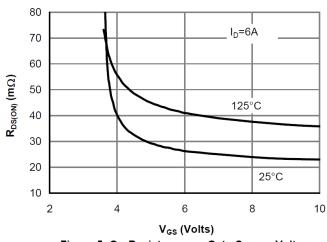


Figure 5: On-Resistance vs. Gate-Source Voltage

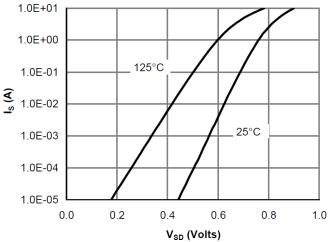
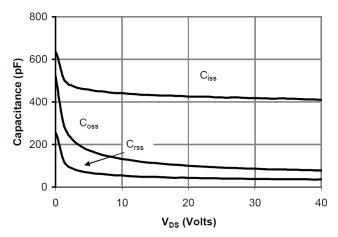


Figure 6: Body-Diode Characteristics

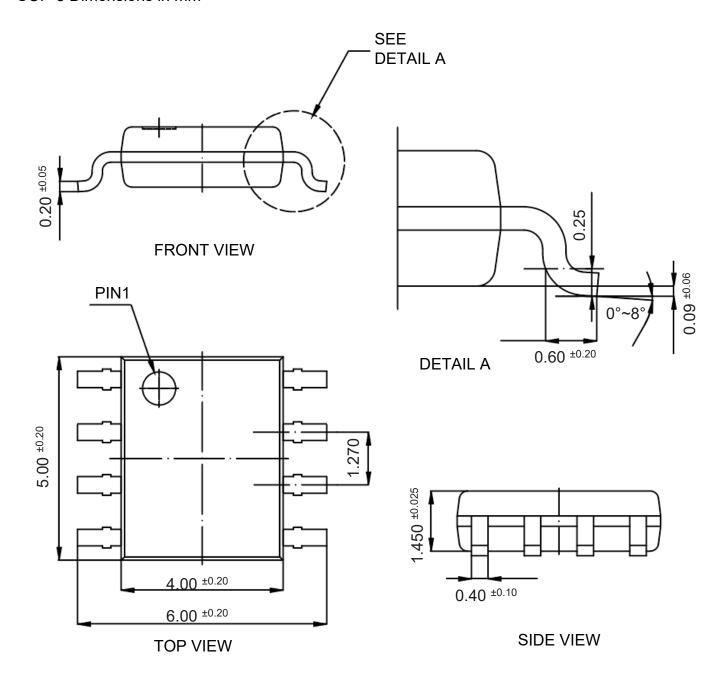
# **Typical Characteristic Curves**



**Figure 7: Capacitance Characteristics** 

# **Package Outline**

#### SOP-8 Dimensions in mm



#### **Ordering Information**

Device	Package	Shipping
TNG07N40PA	SOP-8	4,000PCS/Reel&13inches

#### **Contact Information**

TANI website: http://www.tanisemi.com Email:tani@tanisemi.com

For additional information, please contact your local Sales Representative.



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#### **Product Specification Statement**

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The product parameters described in the product specification are numerical values, characteristics, and functions obtained through actual testing or theoretical calculations of the product in an independent or ideal state. Due to the complexity of product applications and variations in test conditions and equipment, there may be slight fluctuations in parameter test values. TANI shall not guarantee that the actual performance of the product when installed in the customer's system or equipment will be entirely consistent with the product specification, especially concerning dynamic parameters. It is recommended that users consult with professionals for product selection and system design. Users should also thoroughly validate and assess whether the actual parameters and performance when installed in their respective systems or equipment meet their requirements or expectations. Additionally, users should exercise caution in verifying product compatibility issues, and TANI assumes no responsibility for the application of the product. TANI strives to provide accurate and up -to- date information to the best of our ability. However, due to technical, human, or other reasons, TANI cannot guarantee that the information provided in the product specification is entirely accurate and error-free. TANI shall not be held responsible for any losses or damages resulting from the use or reliance on any information in these product specifications.

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